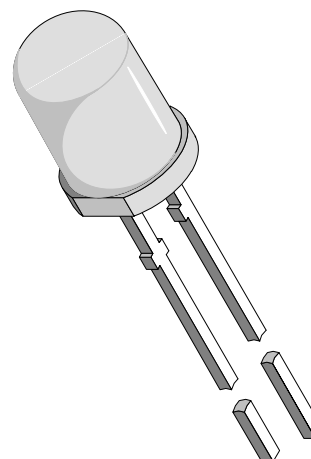


# GaAs Infrared Emitting Diodes in $\varnothing 5$ mm (T-1 $\frac{3}{4}$ ) Package

## Description

TSUS520. series are infrared emitting diodes in standard GaAs on GaAs technology, molded in a clear, blue-grey tinted plastic package. The devices are spectrally matched to silicon photodiodes and phototransistors.



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## Features

- Low cost emitter
- Low forward voltage
- High radiant power and radiant intensity
- Suitable for DC and high pulse current operation
- Standard T-1 $\frac{3}{4}$  ( $\varnothing 5$  mm) package
- Angle of half intensity  $\phi = \pm 15^\circ$
- Peak wavelength  $\lambda_p = 950$  nm
- High reliability
- Good spectral matching to Si photodetectors

## Applications

- Infrared remote control and free air transmission systems with low forward voltage and low cost requirements in combination with PIN photodiodes or phototransistors.

## Absolute Maximum Ratings

$T_{amb} = 25^\circ\text{C}$

Parameter	Test Conditions	Symbol	Value	Unit
Reverse Voltage		$V_R$	5	V
Forward Current		$I_F$	150	mA
Peak Forward Current	$t_p/T = 0.5$ , $t_p = 100 \mu\text{s}$	$I_{FM}$	300	mA
Surge Forward Current	$t_p = 100 \mu\text{s}$	$I_{FSM}$	2.5	A
Power Dissipation		$P_V$	210	mW
Junction Temperature		$T_j$	100	$^\circ\text{C}$
Operating Temperature Range		$T_{amb}$	$-55...+100$	$^\circ\text{C}$
Storage Temperature Range		$T_{stg}$	$-55...+100$	$^\circ\text{C}$
Soldering Temperature	$t \leq 5$ sec, 2 mm from case	$T_{sd}$	260	$^\circ\text{C}$
Thermal Resistance Junction/Ambient		$R_{thJA}$	375	K/W

### Basic Characteristics

$T_{amb} = 25^{\circ}\text{C}$

Parameter	Test Conditions	Type	Symbol	Min.	Typ.	Max.	Unit
Forward Voltage	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$		$V_F$		1.3	1.7	V
	$I_F = 1.5 \text{ A}, t_p = 100 \mu\text{s}$		$V_F$		2.2	3.4	V
Temp. Coefficient of $V_F$	$I_F = 100 \text{ mA}$		$TK_{V_F}$		-1.3		mV/K
Reverse Current	$V_R = 5 \text{ V}$		$I_R$			100	$\mu\text{A}$
Junction Capacitance	$V_R = 0 \text{ V}, f = 1 \text{ MHz}, E = 0$		$C_j$		30		pF
Radiant Intensity	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	TSUS5200	$I_e$	10	20		mW/sr
		TSUS5201	$I_e$	15	25		mW/sr
		TSUS5202	$I_e$	20	30		mW/sr
	$I_F = 1.5 \text{ A}, t_p = 100 \mu\text{s}$	TSUS5200	$I_e$	95	180		mW/sr
		TSUS5201	$I_e$	120	230		mW/sr
		TSUS5202	$I_e$	170	280		mW/sr
Radiant Power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	TSUS5200	$\phi_e$		13		mW
		TSUS5201	$\phi_e$		14		mW
		TSUS5202	$\phi_e$		15		mW
Temp. Coefficient of $\phi_e$	$I_F = 20 \text{ mA}$		$TK_{\phi_e}$		-0.8		%/K
Angle of Half Intensity			$\phi$		$\pm 15$		deg
Peak Wavelength	$I_F = 100 \text{ mA}$		$\lambda_p$		950		nm
Spectral Bandwidth	$I_F = 100 \text{ mA}$		$\Delta\lambda$		50		nm
Temp. Coefficient of $\lambda_p$	$I_F = 100 \text{ mA}$		$TK_{\lambda_p}$		0.2		nm/K
Rise Time	$I_F = 100 \text{ mA}$		$t_r$		800		ns
	$I_F = 1.5 \text{ A}$		$t_r$		400		ns
Fall Time	$I_F = 100 \text{ mA}$		$t_f$		800		ns
	$I_F = 1.5 \text{ A}$		$t_f$		400		ns

**Typical Characteristics** ( $T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified)

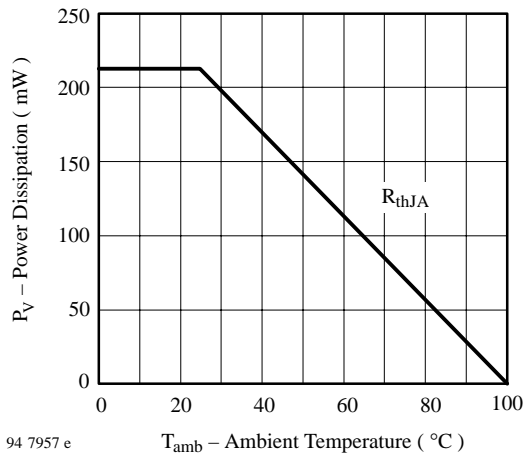


Figure 1. Power Dissipation vs. Ambient Temperature

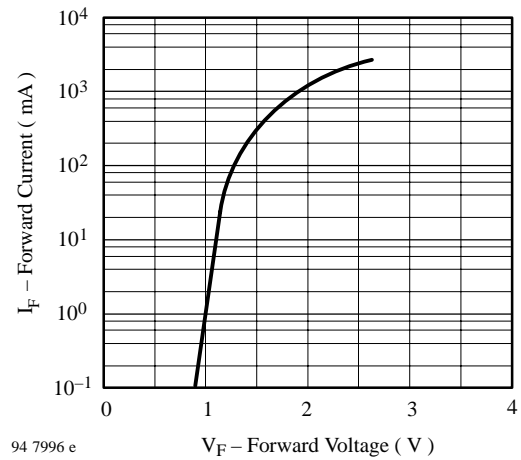


Figure 4. Forward Current vs. Forward Voltage

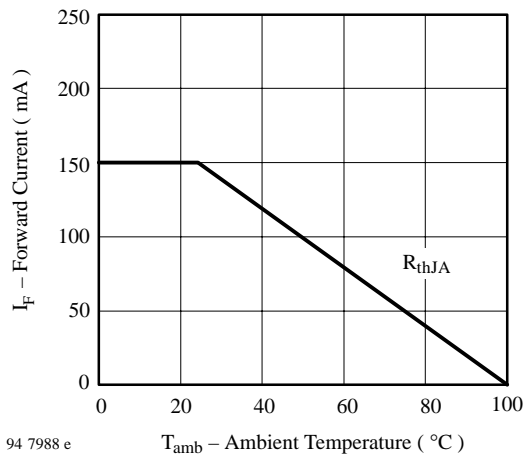


Figure 2. Forward Current vs. Ambient Temperature

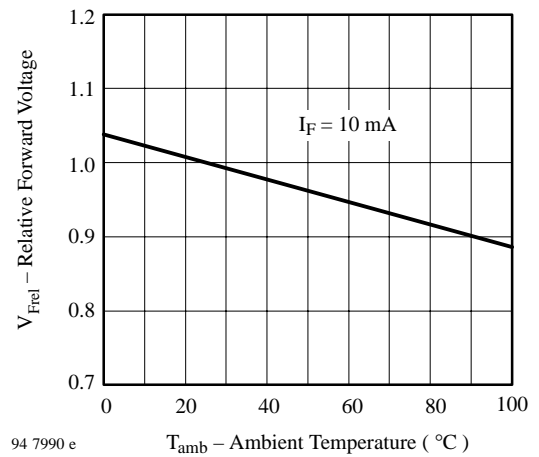


Figure 5. Relative Forward Voltage vs. Ambient Temperature

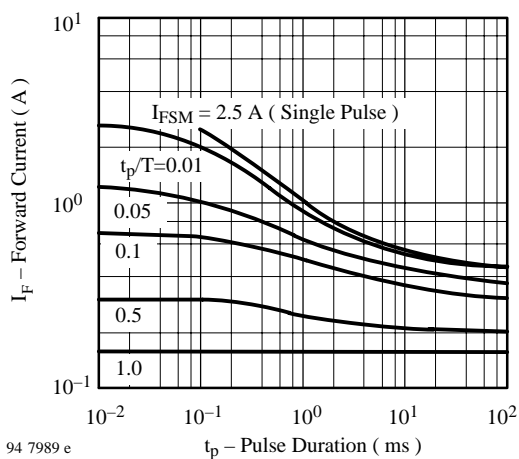


Figure 3. bPulse Forward Current vs. Pulse Duration

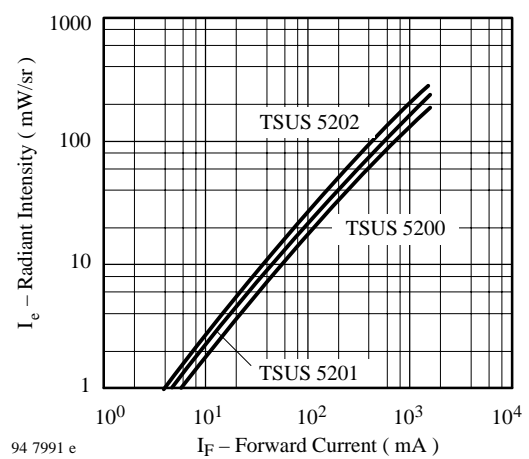


Figure 6. Radiant Intensity vs. Forward Current

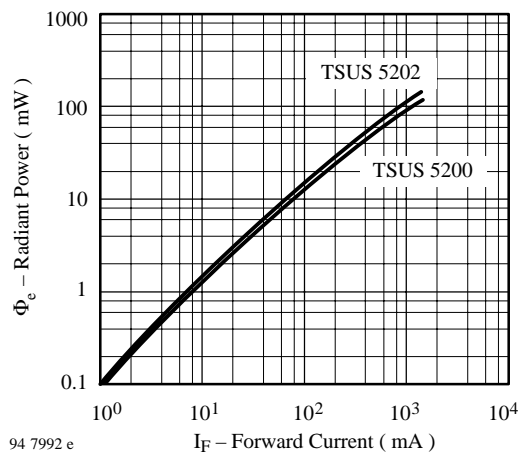


Figure 7. Radiant Power vs. Forward Current

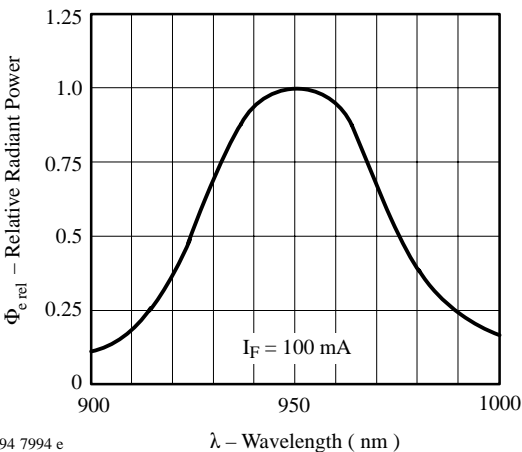


Figure 9. Relative Radiant Power vs. Wavelength

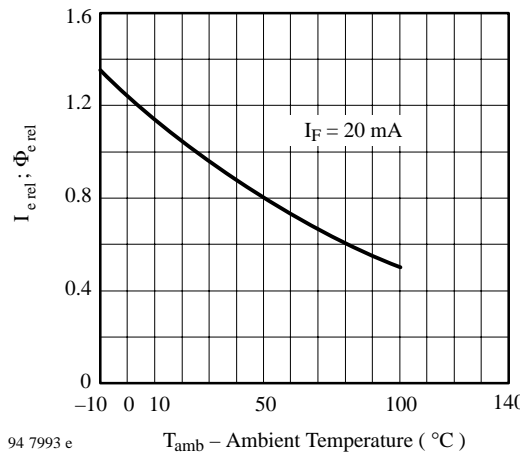


Figure 8. Rel. Radiant Intensity/Power vs. Ambient Temperature

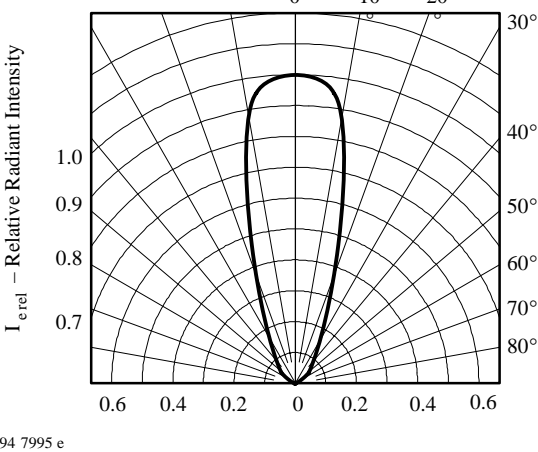
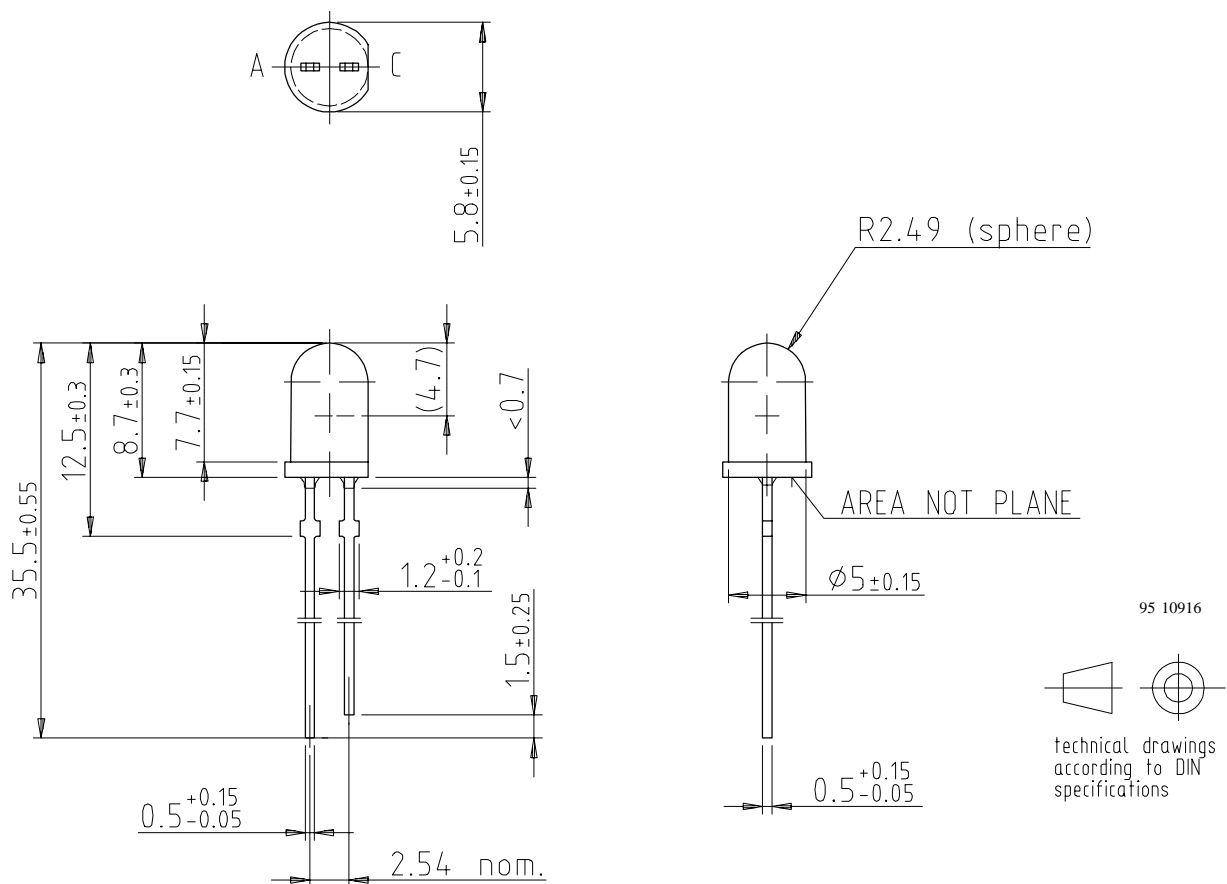


Figure 10. Relative Radiant Intensity vs. Angular Displacement

**Dimensions in mm**





### Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**Vishay Semiconductor GmbH** has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

**Vishay Semiconductor GmbH** can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

**We reserve the right to make changes to improve technical design and may do so without further notice.**

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Telefunken products for any unintended or unauthorized application, the buyer shall indemnify Vishay Telefunken against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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